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Application Data Sheet

Application Information

Application Type:: Regular

Subject Matter:: Utility

Suggested Group Art Unit:: N/A

CD-ROM or CD-R?:: None

Sequence submission?:: None

Computer Readable Form (CRF)?:: No

Title:: SUBSTRATE PROCESSING APPARATUS

AND SEMICONDUCTOR DEVICE

PRODUCING METHOD

Attorney Docket Number:: 2342-0147PUS1

Request for Early Publication?:: No

Request for Non-Publication?:: No

Total Drawing Sheets:: 5

Small Entity?:: No

Petition included?::

Secrecy Order in Parent Appl.?:: No

Applicant Information

Applicant Authority Type:: Inventor

Status:: Full Capacity

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MKM/dns

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Correspondence Information

Correspondence Customer Number:: 02292

Representative Information

Representative Customer Number:: 02292

Domestic Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	National Stage of	PCT/JP2005/003279	02/28/05

Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::
Japan	2004-056363	03/01/04	Yes

Assignee Information

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